## IVERSITY OF DAR ES SALAAM-COLLEGE OF INFORMATION AND COMMUNICATION TECHNOLOGIES

## IS 258: PC MAINTANANCE (3 UNITS)

It marks add up to 100% be precise and to the point beare your work is readable  one:  the the most correct answer out of alternatives given  i. Which of the following terms are measures of CPU speed?  a. Megahertz and gigahertz  b. Megahertz and gigabytes  c. Megahertz and gigabytes  d. Frontside bus, backside bus  i. What do you need to install on top of your CPU to keep it from overheating?  a. RAM  b. Heat sink assembly  c. Thermal dissipater  d. CPU disperser  d. CPU disperser  d. CPU disperser  i. How should you handle RAM?  a. Touch only the gold contacts at the bottom of the stick.  b. Touch only the edges, never the gold contacts.  c. You should only use special tongs when handling RAM.  d. It is unsafe to ever handle RAM.  what is true about a double-sided DIMM?  a. It has memory chips on the front and back.  b. It can be installed forward or backwards.  c. It is twice as fast as a single-sided DIMM.  d. It has half the capacity of a quad-sided DIMM  Which of the following is/are not part of the CPU?	TIME 0730-090	0 2013-04-025	551	DATE: 11th Jun	e, 2015
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